

2N6661/VN88AFD

N-Channel Enhancement-Mode MOSFET Transistors

Product Summary

Part Number	V _{(BR)DSS} Min (V)	r _{D(on)} Max (Ω)	V _{GS(th)} (V)	I _D (A)
2N6661	90	4 @ V _{GS} = 10 V	0.8 to 2	0.9
VN88AFD	80	4 @ V _{GS} = 10 V	0.8 to 2.5	1.29

Features

- Low On-Resistance: 3.6 Ω
- Low Threshold: 1.6 V
- Low Input Capacitance: 35 pF
- Fast Switching Speed: 6 ns
- Low Input and Output Leakage

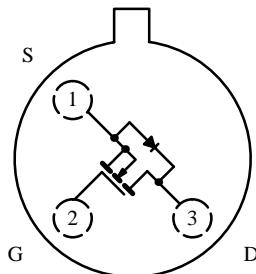
Benefits

- Low Offset Voltage
- Low-Voltage Operation
- Easily Driven Without Buffer
- High-Speed Circuits
- Low Error Voltage

Applications

- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Battery Operated Systems
- Solid-State Relays

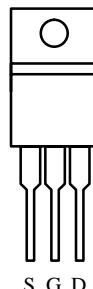
TO-205AD
(TO-39)



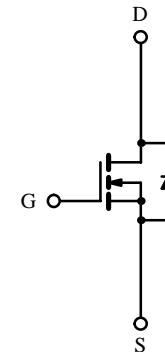
Top View

2N6661

TO-220SD
(Tab-Drain)



Front View



N-Channel MOSFET

VN88AFD

Absolute Maximum Ratings (T_C = 25°C Unless Otherwise Noted)

Parameter	Symbol	2N6661	VN88AFD	Unit
Drain-Source Voltage	V _{DS}	90	80	V
Gate-Source Voltage	V _{GS}	±20	±30	
Continuous Drain Current (T _J = 150°C)	T _C = 25°C	I _D	0.9	A
	T _C = 100°C		0.7	
Pulsed Drain Current ^a	I _{DM}	±3	±3	
Power Dissipation	T _C = 25°C	P _D	6.25	W
	T _C = 100°C		2.5	
Maximum Junction-to-Ambient ^b	R _{thJA}	170		°C/W
Maximum Junction-to-Case	R _{thJC}		8.3	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150		°C

Notes

a. Pulse width limited by maximum junction temperature.

b. This parameter not registered with JEDEC.

Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70224.

2N6661/VN88AFD

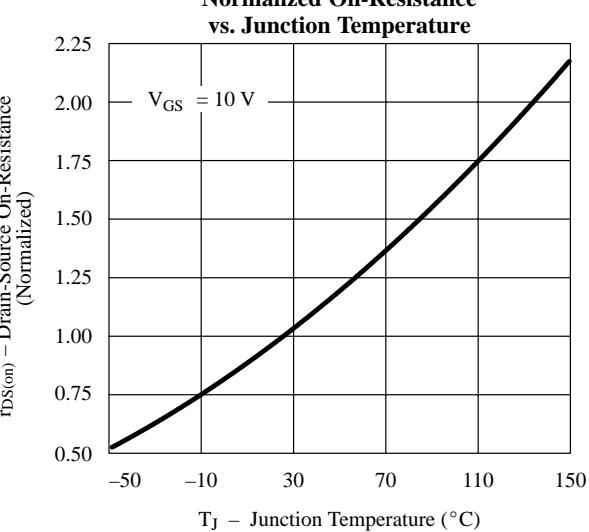
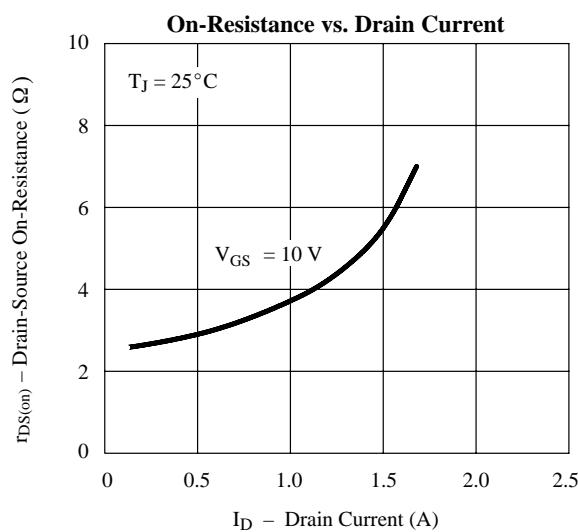
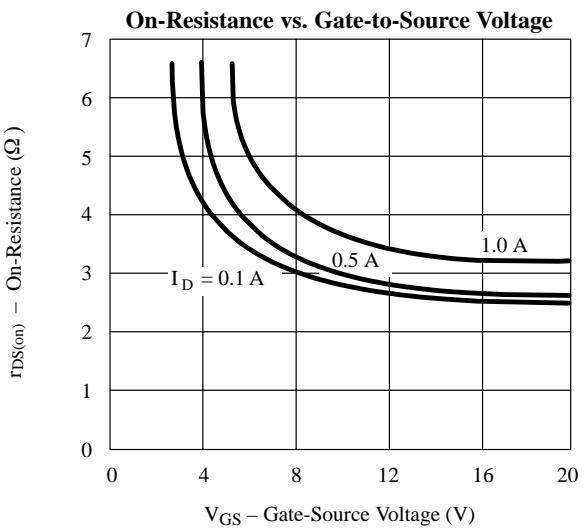
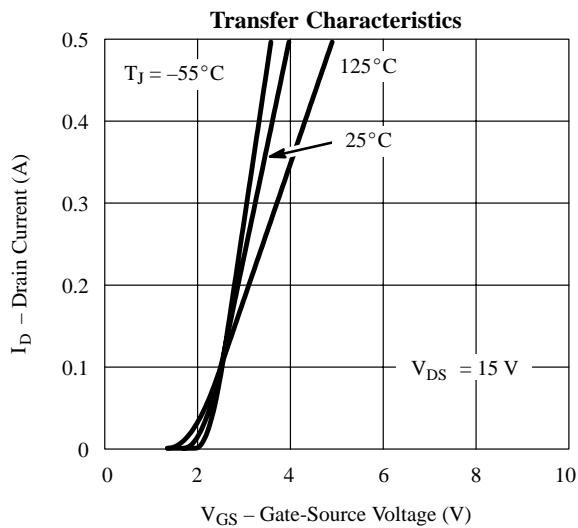
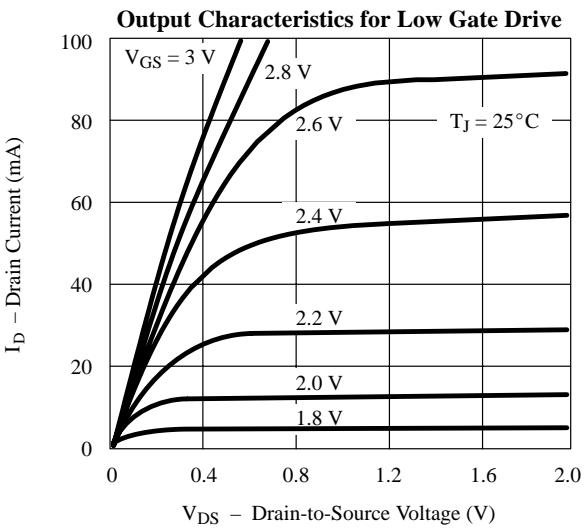
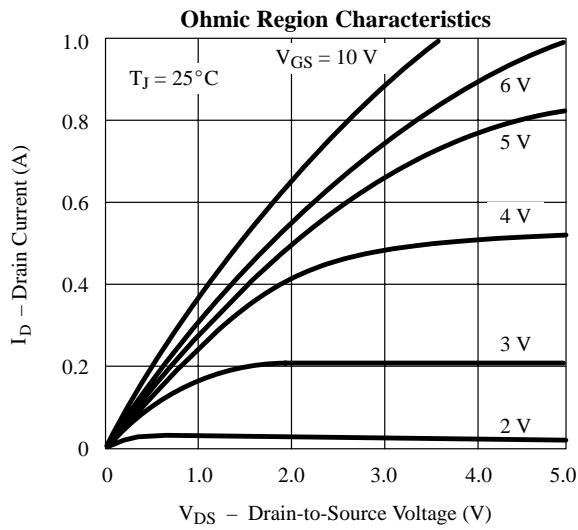
Specifications^a

Parameter	Symbol	Test Conditions	Typ ^b	Limits				Unit	
				2N6661		VN88AFD			
				Min	Max	Min	Max		
Static									
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 10 µA	125	90		80		V	
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 1 mA T _C = 55°C T _C = 125°C	1.6	0.8	2	0.8	2.5		
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 15 V T _C = 125°C			± 100		± 100	nA	
					± 500		± 500		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 90 V, V _{GS} = 0 V			10			µA	
		V _{DS} = 80 V, V _{GS} = 0 V					10		
		V _{DS} = 0.8 x V _{(BR)DSS} , V _{GS} = 0 V T _C = 125°C					1		
					500		500		
On-State Drain Current ^c	I _{D(on)}	V _{DS} = 15 V, V _{GS} = 10 V	1.8	1.5				A	
		V _{DS} = 10 V, V _{GS} = 10 V	1.8			1.5			
Drain-Source On-Resistance ^c	r _{DS(on)}	V _{GS} = 5 V, I _D = 0.3 A	3.8		5.3		5.6	Ω	
		V _{GS} = 10 V, I _D = 1 A T _C = 125°C ^e	3.6		4		4		
			6.7		9		8		
Forward Transconductance ^c	g _{fs}	V _{DS} = 10 V, I _D = 0.5 A	350	170		170		mS	
Diode Forward Voltage	V _{SD}	I _S = 0.86 A, V _{GS} = 0 V	0.9					V	
Dynamic									
Input Capacitance	C _{iss}	V _{DS} = 24 V, V _{GS} = 0 V f = 1 MHz	35		50		50	pF	
Output Capacitance	C _{oss}		15		40		40		
Reverse Transfer Capacitance	C _{rss}		2		10		10		
Drain-Source Capacitance	C _{ds}		30		40				
Switching^d									
Turn-On Time	t _{ON}	V _{DD} = 25 V, R _L = 23 Ω I _D ≈ 1 A, V _{GEN} = 10 V R _G = 25 Ω	6		10		15	ns	
Turn-Off Time	t _{OFF}		8		10		15		

Notes

- a. T_A = 25°C unless otherwise noted.
- b. For DESIGN AID ONLY, not subject to production testing.
- c. Pulse test: PW ≤ 300 µs duty cycle ≤ 2%.
- d. Switching time is essentially independent of operating temperature.
- e. This parameter not registered with JEDEC.

Typical Characteristics (25°C Unless Otherwise Noted)



2N6661/VN88AFD

Typical Characteristics (25°C Unless Otherwise Noted) (Cont'd)

